

General Type

Normal & Miniature Style [MMF Series]



INTRODUCTION

The MMF Series Melf Metal Film Resistors are manufactured using a vacuum sputtering system to deposit multiple layers of mixed metal alloys and passivative materials onto a carefully treated high grade ceramic substrate. SMD enabled structure.

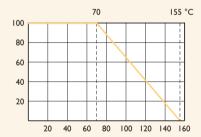
FFATURES

Power Rating 1/6W, 1/4W, 0.4W, 1/2W, 0.6W, 1W		
Resistance Tolerance	±0.1%, ±0.25%, ±0.5%, ±1%, ±2%, ±5%	
T,C.R.	±15ppm/°C, ±25ppm/°C, ±50ppm/°C, ±100ppm/°C	

DERATING CURVE

For resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with the curve below.

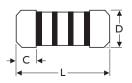
Rated Load (%)



Ambient Temperature (°C)

DIMENSIONS

Unit: mm



STYLE		DIMENSION			
Normal	Miniature	L	D	C Min.	
MMF-12	MMF25S / MMF204	3.50±0.2	1.40±0.15	0.5	
MMF-25	MMF50S / MMF207	5.90±0.2	2.20±0.1	0.5	
MMF-50	MMFIWS	8.50±0.2	3.20±0.2	0.5	

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Note:		

ELECTRICAL CHARACTERISTICS

STYLE	MMF-12	MMF25S	MMF204	MMF-25	MMF50S	MMF207	MMF-50	MMFIWS
Power Rating at 70°C	1/6W	1/4W	0.4VV	1/4W	1/2W	0.6W	1/2W	IW
Maximum Working Voltage	150V	200V		250V			350V	
Maximum Overload Voltage	300V	400V		500V			700V	
Voltage Proof on Insulation	300V			500V			700V	
Resistance Range	0.22Ω -3.9 Ω for tol ±5%, E96 series value, 4 Ω - $ M\Omega $ for tol ±1% E24 + E96 series value							
Operating Temp, Range	-55°C to +155°C							
Temperature Coefficient	\pm 50ppm/°C for 4 Ω - 1M Ω , \pm 100ppm/°C for 0.22 Ω - 3.9 Ω							

Note: Special value is available on request

ENVIRONMENTAL CHARACTERISTICS

PERFORMANCE TEST	TEST METHOD		APPRAISE	
Short Time Overload	ort Time Overload IEC 60115-1 4.13 2.5 times RCWV for 5 sec. (Not more than maximum Overload Voltage)		±0.5%+0.05Ω	
Voltage Proof on Insulation	IEC 60115-1 4.7	In V-Block for 60 sec., test voltage as above table	No Breakdown	
Temperature Coefficient	IEC 60115-1 4.8	Between -55°C to +155°C	By type	
Insulation Resistance	IEC 60115-1 4.6	in V-block for 60 Sec.	>10,000MΩ	
Solderability	IEC 60115-1 4.17	245±5°C for 3±0.5 Sec.	95% Min. coverage	
Solvent Resistance of Marking	IEC 60115-1 4.30	IPA for 5±0.5 Min. with ultrasonic	No deterioration of coatings and markings	
Periodic-pulse Overload	IEC 60115-1 4.39	4 times RCWV 10,000 cycles (1 Sec. on, 25 Sec. off)	±1.0%+0.05Ω	
Damp Heat Steady State	IEC 60115-1 4.24	40±2°C, 90-95% RH for 56 days, loaded with 0.1 times RCWV	±2.0%+0.1Ω	
Endurance at 70°C	IEC 60115-1 4.25	70±2°C at RCWV (or Umax., Whichever less) for 1,000 Hr. (1.5Hr.on, 0.5Hr. Off)	±2,0%+0.1Ω	
Temperature Cycling	IEC 60115-1 4.19	-55°C ⇒ Room Temp. ⇒ +155°C ⇒ Room Temp. (5 cycles)	±0.75%+0.05Ω	
Resistance to Soldering Heat	IEC 60115-1 4.18	260±3°C for I0±1 Sec., immersed to a point 3±0.5mm from the body	±0.5%+0.05Ω	